

**Declaration for the REACH-regulation (Release date 16-July-2019)**

Dear Sir or Madam,

Our articles Thermally conductive adhesive WLK DK [...] contain a substance of the candidate list (SVHC). Part B of this product contains 4,4'-isopropylidenediphenol (CAS 80-05-7) in less than 3 %w/w.

The following articles contain lead (CAS 7439-92-1) as alloying element using RoHS-exemptions:

ABM [...]  
AHM [...]  
BL 5 [...] (contact base alloy)  
BL 6 [...] (contact base alloy)  
BL 8 [...] (contact base alloy)  
BL 9 [...] (contact base alloy)  
BL 10 [...] (contact base alloy)  
BL 16 SMD [...] (contact base alloy)  
BL 18 [...] (contact base alloy)  
BL 19 [...] (contact base alloy)  
BLY [...] (contact base alloy)  
ELS 3  
GBM [...]  
LA [...] (fan)  
LAM [...] (fan)  
LAV [...] (fan)  
MK [...] (contact base alloy)  
PK [...] (contact base alloy)  
SB [...] (contact base alloy)  
SK 08 and 42 G (contact base alloy)  
SL 8 [...] (contact base alloy)

With kind regards

FISCHER ELEKTRONIK GMBH & CO. KG

Lüdenscheid, 02-Aug-2019



i.V. Dr. Michael Pohler